

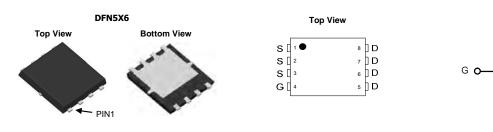
AON6242-VB Datasheet N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a					
60	0.003 at V _{GS} = 10 V	100					
60	0.005 at V _{GS} = 4.5 V	85					

FEATURES

- 175 °C Junction Temperature
- Trench Power MOSFET
- Material categorization:





S N-Channel MOSFET

D

ABSOLUTE MAXIMUM RATINGS (T $_{\rm C}$ =	= 25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current (T _{.1} = 175 °C) ^b	T _C = 25 °C	1-	100	_
Continuous Drain Current $(1_J = 175 \text{ °C})^2$	T _C = 100 °C	I _D	85 ^a	
Pulsed Drain Current	I _{DM}	100	А	
Continuous Source Current (Diode Conduction)	۱ _S	80 ^a		
Avalanche Current	I _{AS}	70		
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	125	mJ
Maximum Dawar Dissinction	T _C = 25 °C	P _D	136	w
Maximum Power Dissipation	T _A = 25 °C		3 ^b , 8.3 ^{b, c}	VV
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	R _{thJA}	15	18				
Maximum Junction-to-Ambient*	Steady State	I thJA	40	50	°C/W			
Maximum Junction-to-Case		R _{thJC}	0.85	1.1				
Notes:			•					

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.



Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit
Static	•			•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$				V
Gate Threshold Voltage	e Threshold Voltage $V_{GS(th)}$ $V_{DS} = V_{GS}$, I _D		1	2	3	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C			50	μA
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			250	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	60			А
		V _{GS} = 10 V, I _D = 20 A		0.003		
- ·		V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.008		0
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.010		Ω
		V _{GS} = 4.5 V, I _D = 15 A		0.005		_
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S
Dynamic			-			
Input Capacitance	C _{iss}			2650		
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		470		pF
Reverse Transfer Capacitance	C _{rss}			225		
Total Gate Charge ^c	Qg			47	70	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 50 A		10		nC
Gate-Drain Charge ^c	Q _{gd}			12		
Turn-On Delay Time ^c	t _{d(on)}			10	20	
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		15	25	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		35	50	ns
Fall Time ^c	t _f			20	30	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)		·	· ·	
Pulsed Current	I _{SM}				60	А
Diode Forward Voltage	V _{SD}	I _F = 20 A, V _{GS} = 0 V		1	1.5	V
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		45	100	ns

SPECIFICATIONS (T ₁ = 25 °C, unless otherwise no	noted	rwise	otherwis	unless	= 25 °C.	(Т і	NS	0	ΔΤΙ	IC.	CIF	SPE	
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Notes:

a. For design aid only; not subject to production testing.

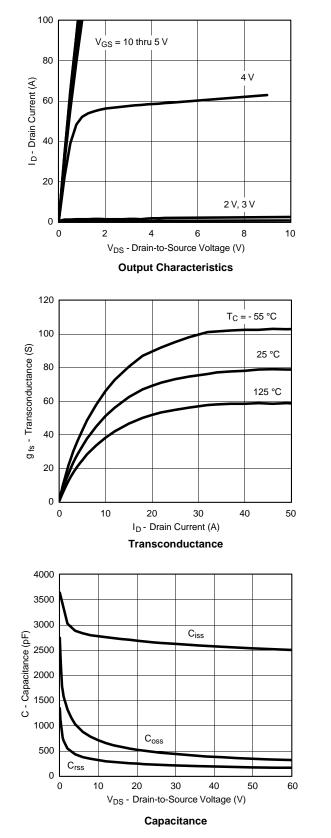
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

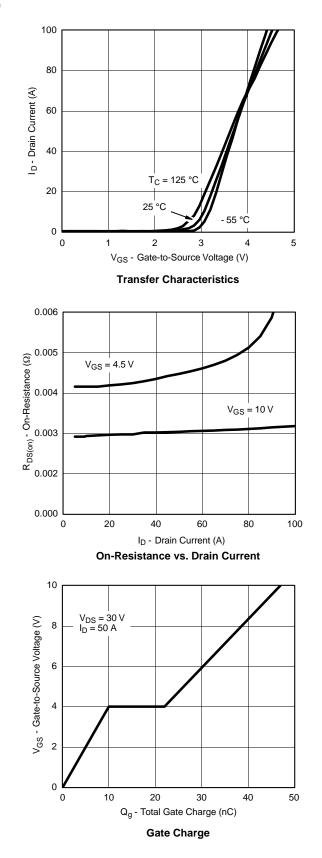
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

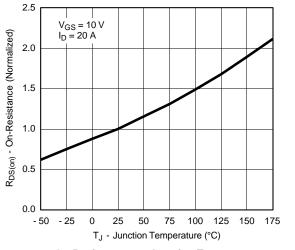


TYPICAL CHARACTERISTICS (25 °C unless noted)



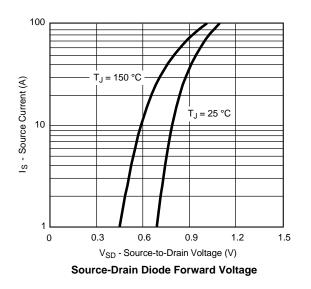






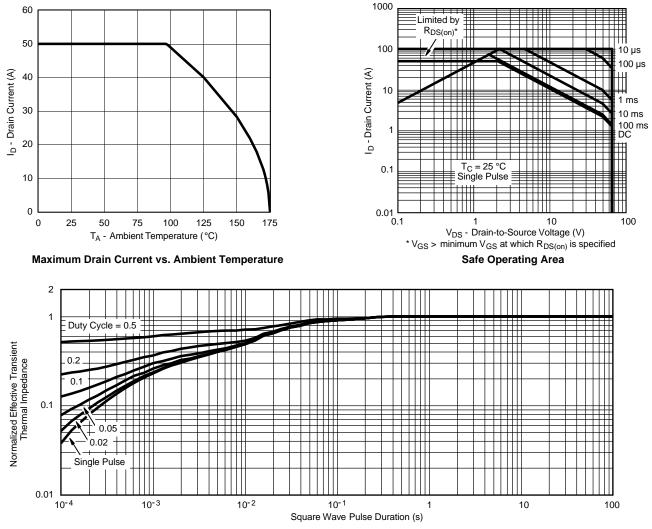
TYPICAL CHARACTERISTICS (25 °C unless noted)

On-Resistance vs. Junction Temperature



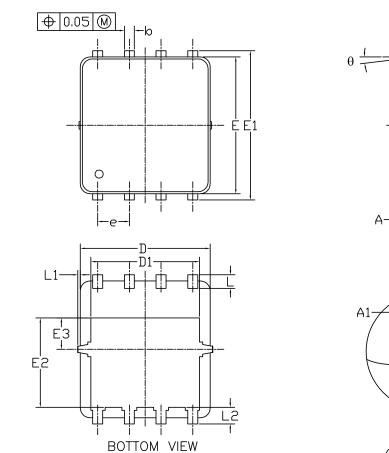


THERMAL RATINGS

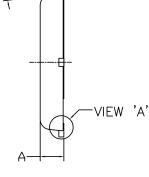


Normalized Thermal Transient Impedance, Junction-to-Case

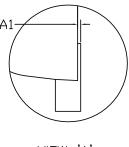




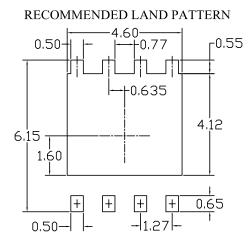
DFN5x6_8L_EP1_P PACKAGE OUTLIN



С



<u>VIEW 'A'</u> (SCALE 5:1)



SYMBOLS	DIMENS	IONS IN MILLI	METERS	DIMENSIONS IN INCHES			
STMBOLS	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.85	0.95	1.00	0.033	0.037	0.039	
Al	0.00		0.05	0.000		0.002	
b	0.30	0.40	0.50	0.012	0.016	0.020	
с	0.15	0.20	0.25	0.006	0.008	0.010	
D	5.10	5.20	5.30	0.201	0.205	0.209	
D1	4.25	4.35	4.45	0.167	0.171	0.175	
E	5.45	5.55	5.65	0.215	0.219	0.222	
E1	5.95	6.05	6.15	0.234	0.238	0.242	
E2	3.525	3.625	3.725	0.139	0.143	0.147	
E3	1.175	1.275	1.375	0.046	0.050	0.054	
e		1.27 BSC			0.050 BSC		
L	0.45	0.55	0.65	0.018	0.022	0.026	
L1	0		0.15	0		0.006	
L2		0.68 REF		0.027 REF			
θ	0°		10°	0°		10°	

NOTE

UNIT: mm

 PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.



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